### PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
HIROYUKI CHIBA	04/05/2018
YOSHINOBU HOSHINO	03/14/2018
SHIGERU KAWAMATA	03/13/2018

### **RECEIVING PARTY DATA**

Name:	HITACHI HIGH-TECHNOLOGIES CORPORATION	
Street Address:	et Address: 24-14, NISHI-SHIMBASHI 1-CHOME	
Internal Address:	MINATO-KU	
City:	TOKYO	
State/Country:	JAPAN	
Postal Code:	105-8717	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15773445

### CORRESPONDENCE DATA

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Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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Email: Ihennessey@vklaw.com **Correspondent Name:** VOLPE AND KOENIG, P.C.

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ATTORNEY DOCKET NUMBER:	HITACHI7-111501657US01
NAME OF SUBMITTER:	GERALD B. HALT, JR.
SIGNATURE:	/Gerald B. Halt, Jr./
DATE SIGNED:	05/04/2018

**Total Attachments: 3** 

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PATENT REEL: 045713 FRAME: 0351

### ASSIGNMENT (譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI HIGH-TECHNOLOGIES CORPORATION, a corporation organized under the laws of Japan,

located at 24-14, Nishi Shimbashi 1-chome, Minato-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said

HITACHI HIGH-TECHNOLOGIES CORPORATION.

its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

# CHARGED PARTICLE BEAM APPARATUS, OBSERVATION METHOD USING CHARGED PARTICLE BEAM APPARATUS, AND PROGRAM

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, No.PCT/JP2015/082989 filed 25 November 2015, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said HITACHI HIGH-TECHNOLOGIES CORPORATION,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made:

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI HIGH-TECHNOLOGIES CORPORATION,

Signed on the date(s) indicated aside our signatures:

BIVENITOD/C)

	(発明者フルネームサイン)	(署名日)
1)	Hiroyuki Chiba	4/5/2018
2)	Hiroyuki CHIBA	,
3)	Yoshinabu HOSHINO	
***************************************	Shigeru KAWAMATA	
4)		
5)		
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9)		
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PATENT REEL: 045713 FRAME: 0352

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to be held and enjoyed by said. HITACHI HIGH-TECHNOLOGIES CORPORATION,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

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And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI HIGH-TECHNOLOGIES CORPORATION,

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)

(発明者フルネームサイン)

•••			Hiroyuki CHIBA	
2)	Ynskinolu	Hookins	*	3/14/2018
••••			Yoshinobu HOSHINO	· · · · · · · · · · · · · · · · · · ·
3)				
	······		Shinen KAMMAMATA	

Yoshinobu HOSHINO

3)

Shigeru KAWAMATA

4)

6)

7)

8)

PATENT REEL: 045713 FRAME: 0353

Date Signed

(署名目)

### ASSIGNMENT (譲渡証)

As a below named inventor, I hereby declare that:

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Signed on the date(s) indicated aside our signatures:

RECORDED: 05/04/2018

IND/ENTOPICS

(発明者フルネームサイン)		(署名日)	
1)			
2)	Hiroyuki CHIBA		
	Yoshinobu HOSHINO		
3)_	Shizeru Kawamata	3/13/2018	
4)	Shigeru KAWAMATA		
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